

FDD8445

N-Channel PowerTrench[®] MOSFET 40V, 50A, 8.7m Ω

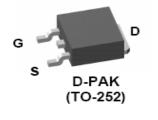
Features

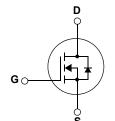
- $R_{DS(ON)}$ = 6.7 m Ω (Typ), V_{GS} = 10V, I_D =50A
- Q_{g(10)} = 45nC (Typ), V_{GS}=10V
- Low Miller Charge
- Low Qrr Body Diode
- UIS Capability (Single Pulse/ Repetitive Pulse)
- RoHS Compliant



Applications

- Powertrain Management
- Electronic Transmission
- Distributed Power Architecture and VRMs
- Primary Switch for 12V Systems





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Symbol	Parameter	Ratings	Units
V _{DSS}	Drain to Source Voltage	40	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (V _{GS} =10v) (Note 1)	70	A
I _D	Continuous (V _{GS} =10v,with $R_{\theta JA} = 52^{\circ}C/W$)	15.2	А
	Pulsed	Figure 4	
E _{AS}	SinglePulseAvalancheEnergy (Note2)	144	mJ
Р	Power Dissipation	79	W
P _D	Derate above 25°C	0.53	W/ºC
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.9	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient TO-252, lin ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8445	FDD8445	TO-252AA	13"	12mm	2500 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Charac	cteristics					

BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _G	_S = 0V	40	-	-	V
1	Zero Gate Voltage Drain Current	V _{DS} = 32V		-	-	1	μA
DSS	T _{DSS} Zero Gate voltage Drain Current	$V_{GS} = 0V$	T _J =150°C	-	-	250	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = $\pm 20V$		-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	2.8	4	V
		I _D = 50A, V _{GS} = 10V	-	6.7	8.7	
R _{DS(ON)}	Drain to Source On Resistance	$I_D = 50A, V_{GS} = 10V, T_J = 175^{\circ}C$	-	12.5	16.3	mΩ

Dynamic Characteristics

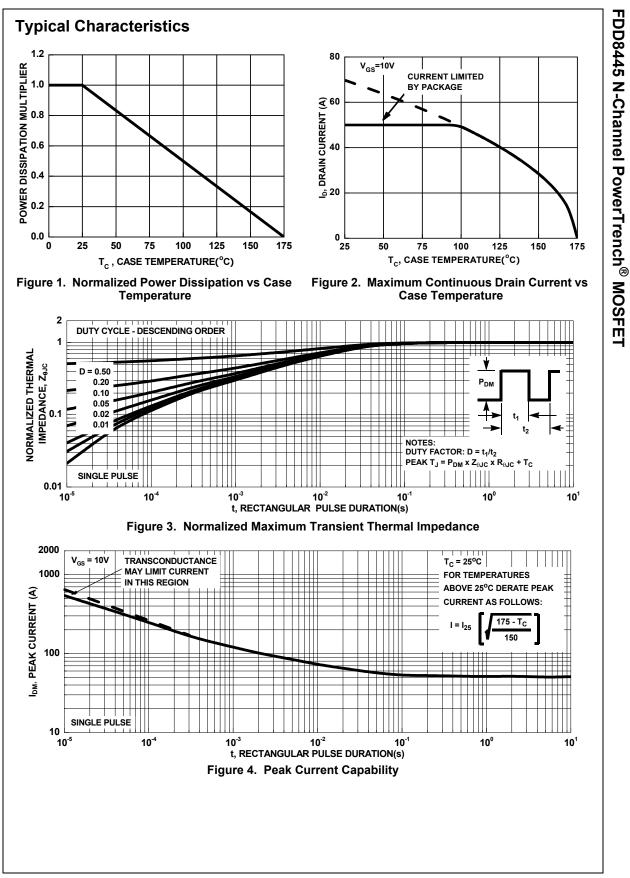
-	1						_
C _{ISS}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	3040	4050	pF
C _{OSS}	Output Capacitance			-	295	390	pF
C _{RSS}	Reverse Transfer Capacitance			-	178	270	pF
R _G	Gate Resistance	f = 1MHz		-	1.7	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	V _{GS} = 0 to 10V		-	45	59	nC
Q _{g(5)}	Total Gate Charge at 5V	V_{GS} = 0 to 5V		-	17	22	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} =20V,	-	5.8	7.6	nC
Q _{gs}	Gate to Source Gate Charge		I _D = 50A	-	12.5	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau			-	9.5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	10.5	-	nC

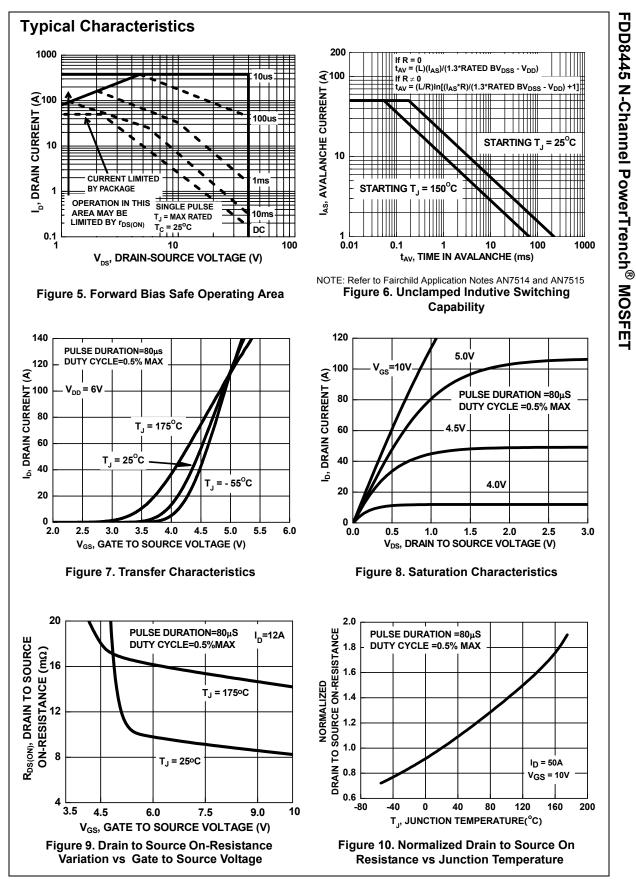
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Switching	g Characteristics					
t _(on)	Turn-On Time	V _{DD} = 20V, I _D = 50A V _{GS} = 10V, R _{GS} = 2Ω	-	-	138	ns
t _{d(on)}	Turn-On Delay Time		-	10	-	ns
t _r	Turn-On Rise Time		-	82	-	ns
t _{d(off)}	Turn-Off Delay Time		-	26	-	ns
t _f	Turn-Off Fall Time		-	9.6	-	ns
t _{off}	Turn-Off Time		-	-	53	ns
t _{off}	Turn-Off Time		-	9.6 -	- 53	
rain-Sou	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Voltage	I _{SD} =50A	-	-	1.25	V
▼ SD	Source to Drain Diode voltage	Isp=25A	-	-	1.0	V

V	Source to Drain Diode Voltage	I _{SD} =50A	1.25		1.25	V
V _{SD}	Source to Drain Diode voltage	I _{SD} =25A	-	-	1.0	V
t _{rr}	Reverse Recovery Time	I _F = 50A, dI _F /dt=100A/μs	-	-	39	ns
Q _{rr}	Reverse Recovery Charge	I _F = 50A, dI _F /dt=100A/μs	-	-	38	nC

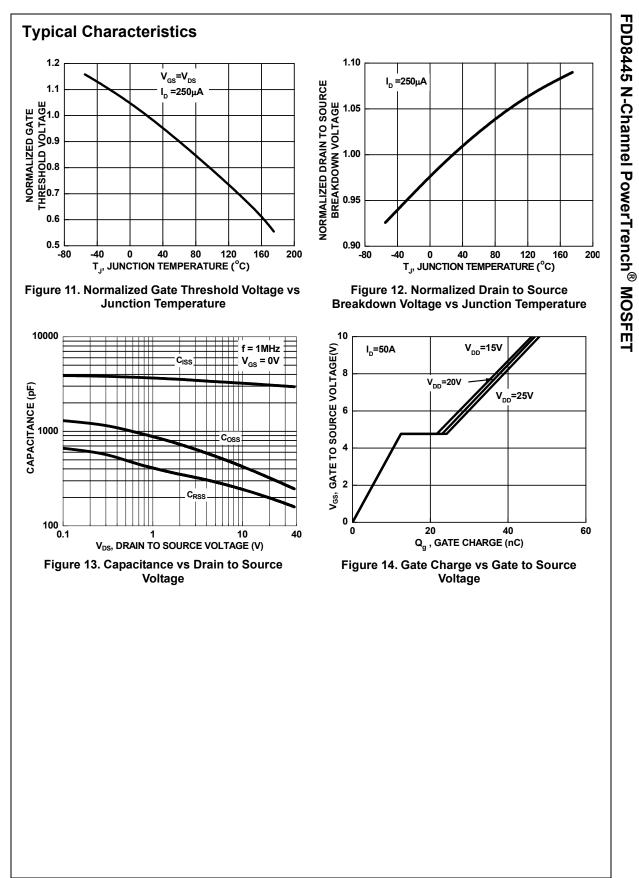
Notes: 1: Maximum package current capability is 50A. 2: Starting $T_J = 25^{\circ}C$, L=0.18mH, I_{AS}=40A.

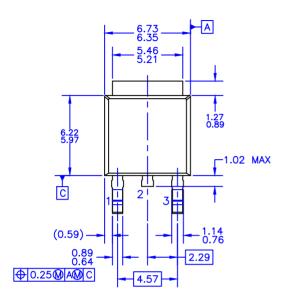
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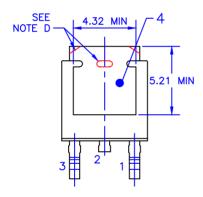


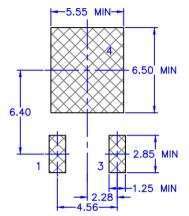


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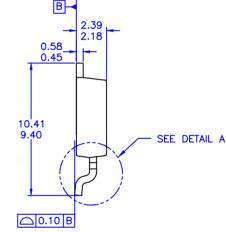


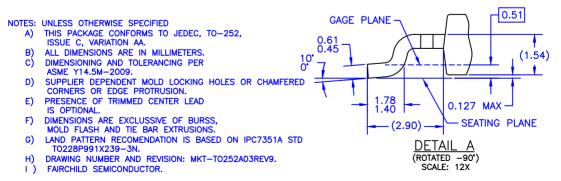


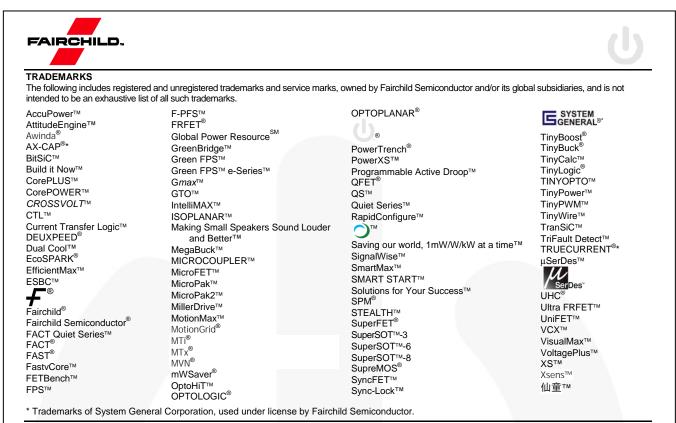




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		Rev. 173